



MAX9706 Evaluation Kit

Evaluates: MAX9706/MAX9707

General Description

The MAX9706 evaluation kit (EV kit) is a fully assembled and tested circuit board that evaluates the MAX9706 as well as the MAX9707 ICs. The MAX9706/MAX9707 contain three Class D amplifiers with an internal active crossover to provide stereo highpass outputs and a mono lowpass output. The IC does not require any external components for the active crossover filter. The MAX9706 also features a DirectDrive™ stereo headphone amplifier.

The MAX9706 speaker amplifier operates from a 4.5V to 5.5V DC power supply, and delivers 2.3W continuous power into each of three 4Ω speakers. Three different speaker output filtering options are available for ease of evaluation (see the *Output Filtering* section).

The MAX9706 headphone amplifier operates from a 3V to 5.5V DC power supply, and delivers up to 95mW per channel into a 16Ω stereo headphone. When the MAX9706 headphone sense detects the insertion of a headphone, the MAX9706 automatically enters the headphone mode.

The EV kit offers an option to select between fixed-frequency modulation (FFM) mode or spread-spectrum modulation (SSM) mode. The EV kit can be synchronized with an external clock, and the EV kit provides a synchronization output that allows multiple units to be cascaded in a system.

The MAX9706 EV kit gain is jumper selectable. The EV kit also features an option to select the crossover frequency between the stereo highpass outputs and the mono lowpass output. The MAX9706 shutdown supply current is only 0.5 μ A (typ).

Features

- ◆ 4.5V to 5.5V Single DC Power-Supply Operation
- ◆ Drives 3 x 2.3W into Three 4Ω Speakers (2.1 Speaker Solutions)
- ◆ Drives 2 x 95mW into a 16Ω Stereo Headphone (MAX9706)
- ◆ Internal Active Crossover Filter with Selectable Crossover Frequency
- ◆ Selectable Gains
- ◆ Selectable Between Spread-Spectrum and Fixed-Frequency Modulation
- ◆ Input and Output Synchronization Signals
- ◆ 0.5 μ A (typ) Shutdown Current
- ◆ Space-Saving 36-Pin TQFN (6mm x 6mm x 0.8mm) Package
- ◆ Fully Assembled and Tested
- ◆ Evaluates MAX9707 (IC Replacement Required)

Ordering Information

PART	TEMP RANGE	IC PACKAGE
MAX9706EVKIT	0°C to +70°C*	36-TQFN-EP** (6mm x 6mm x 0.8mm)

*This limited temperature range is for the EV kit PC board only.

The MAX9706 IC temperature range is -40°C to +85°C.

**EP = Exposed paddle.

Component List

DESIGNATION	QTY	DESCRIPTION
C3, C5	2	0.1 μ F \pm 10%, 10V X7R ceramic capacitors (0402) TDK C1005X7R1A104K
C4, C6, C7, C10, C12, C13, C14	7	1 μ F \pm 10%, 10V X7R ceramic capacitors (0603) TDK C1608X7R1A105K
C8, C9, C11	3	0.47 μ F \pm 10%, 10V X7R ceramic capacitors (0603) TDK C1608X7R1A474K
U1	1	MAX9706ETX (36-pin TQFN-EP, 6mm x 6mm)

DESIGNATION	QTY	DESCRIPTION
OPTIONAL COMPONENTS FOR CUSTOMER EVALUATION		
C1, C36	2	1000pF \pm 10%, 50V X7R ceramic capacitors (0603) TDK C1608X7R1H102K
C2 [†]	1	100 μ F \pm 20%, 6.3V X5R ceramic capacitor (1210) TDK C3225X5R0J107M
C15–C35	0	Not installed, capacitors (0603)
C37, C38	2	100pF \pm 10%, 50V C0G ceramic capacitors (0603) TDK C1608C0G1H101K

[†]System-level requirement.

Component List continued on next page.



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Component List (continued)

DESIGNATION	QTY	DESCRIPTION
OPTIONAL COMPONENTS FOR CUSTOMER EVALUATION		
J1	1	3.5mm switched stereo jack
JU1-JU7	7	3-pin headers
JU8	1	2-pin header
L1	1	Ferrite bead, 30Ω at 100MHz, 10mΩ DCR, 5A (0805) TDK MPZ2012S300A
L2, L3, L10	3	Ferrite beads, 100Ω at 100MHz, 50mΩ DCR, 3A (0603) TDK MPZ1608S101A

DESIGNATION	QTY	DESCRIPTION
OPTIONAL COMPONENTS FOR CUSTOMER EVALUATION		
L4-L9	0	Not installed, inductors Sumida CDRH6D38 series recommended
R1-R6	0	Not installed, resistors (0603)
T1, T2, T3	0	Not installed, common-mode chokes 50VDC, 1.5ADC, 600Ω at 100MHz TDK ACM4532-601-2P-X recommended
—	8	Shunts
—	1	MAX9706 EV kit PC board

Component Suppliers

SUPPLIER	PHONE	FAX	WEBSITE
Sumida USA	847-545-6700	847-545-6720	www.sumida.com
TDK	847-803-6100	847-390-4405	www.component.tdk.com

Note: Indicate that you are using the MAX9706 EV kit when contacting these component suppliers.

Quick Start

Recommended Equipment

- One 5V, 2A DC power supply
- Optional 3V, 1A DC power supply
- Audio source
- Three 4Ω to 8Ω speakers
- Stereo headphone

Procedures

The MAX9706 EV kit is fully assembled and tested. Follow the steps listed below to verify board operation.

Do not turn on the power supply until all connections are completed.

- Install a shunt across pins 1 and 2 of jumper JU1 (EV kit ON).
- Install a shunt across pins 1 and 2 of jumper JU2 (mono speaker gain offset = -7.5dB).
- Install a shunt across pins 1 and 2 of jumpers JU3 and JU4 (stereo speaker gain = +13.5dB, mono speaker gain = +12dB, headphone gain = +3dB).
- Install a shunt across pins 1 and 2 of jumpers JU5 and JU6 (crossover frequency = 2133.3Hz).
- Install a shunt across pins 1 and 2 of jumper JU7 (SSM mode with frequency = 1150kHz ±50kHz).
- Install a shunt on jumper JU8 (speaker enable).

- Connect the first speaker to the OUTL+ and the OUTL- test points.
- Connect the second speaker to the OUTR+ and the OUTR- test points.
- Connect the third speaker to the OUTM+ and the OUTM- test points.
- Connect the +5V DC power supply to the VDD pad. Connect the power-supply ground to the GND pad.
- Connect the +3V DC power supply to the HPVDD pad. Connect the power-supply ground to the GND pad. If the optional +3V DC power supply is not available, connect the HPVDD pad to the VDD pad.
- Connect the audio source to the IN_L and the IN_R pads. Connect the audio source ground to the GND pad.
- Turn on both power supplies and the audio source.
- To test the headphone, plug the headphone to the phone jack J1.

Detailed Description

The MAX9706 EV kit is designed to evaluate the MAX9706 as well as the MAX9707 ICs. The MAX9706/MAX9707 contain three Class D amplifiers with an internal active crossover to provide stereo highpass outputs and a mono lowpass output. The MAX9706 also features a DirectDrive stereo headphone amplifier. The EV kit comes with the MAX9706 IC installed.

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The EV kit's speaker amplifiers operate from a 4.5V to 5.5V DC power supply, and deliver 3 x 2.3W continuous power into three 4Ω speakers. Three different speaker output filtering options are available for ease of evaluation. See the *Output Filtering* section.

The EV kit's DirectDrive headphone amplifier operates from a 3V to 5.5V DC power supply, and delivers 95mW per channel into a 16Ω stereo headphone. Both the speaker and headphone power supplies must be present to operate the EV kit. The EV kit can be powered by a single 4.5V to 5.5V DC power supply.

The EV kit offers an option to select between two frequencies when in fixed-frequency modulation (FFM) mode or a single-center frequency in spread-spectrum modulation (SSM) mode. The MAX9706 EV kit features a synchronization input (SYNCIN) PC board pad that allows the MAX9706 to synchronize with an external clock. The EV kit also provides a synchronization output (SYNCOUT) PC board pad to synchronize other devices to the MAX9706. Refer to the *Operating Modes* section in the MAX9706/MAX9707 IC data sheet for additional information on FFM, SSM, SYNCIN, and SYNCOUT.

The MAX9706's speaker and headphone amplifier gain is configurable using jumpers JU3 and JU4. The mono output gain offset is configurable using jumper JU2. The MAX9706 EV kit also provides a line-level mono-output MONO_OUT PC board pad.

The MAX9706 EV kit features an option to select the crossover frequency between the stereo highpass and mono lowpass frequencies. The crossover frequency is jumper selectable using jumpers JU5 and JU6. Refer to

Table 1. Suggested Filtering Components for a 4Ω Load with a 30kHz Cutoff Frequency

COMPONENT	DESCRIPTION
C21–C26	0.033µF ±10%, 25V X7R ceramic capacitors (0603) TDK C1608X7R1E333K
C27, C28, C29	0.15µF ±10%, 25V X7R ceramic capacitors (0603) TDK C1608X7R1E154K
C30–C35	0.068µF ±10%, 25V X7R ceramic capacitors (0603) TDK C1608X7R1E683K
L4–L9	22µH ±20%, 1.3A inductors Sumida CDRH6D38-220
R1–R6	22Ω ±5% resistors (0603)

the *Crossover Frequency* section in the MAX9706/MAX9707 IC data sheet for additional information on the internal active crossover.

The speaker and headphone outputs on the EV kit can be selected by jumper JU8 and headphone jack J1. See Table 8 in the *Jumper Selection* section.

The EV kit can also evaluate the MAX9707. To evaluate the MAX9707, replace the MAX9706 with the MAX9707. See the *Evaluating the MAX9707* section.

Output Filtering

The speaker outputs (OUTL+/-, OUTR+/-, and OUTM+/-) can be connected directly to three speaker loads without any filtering. Use the OUTL+/-, OUTR+/-, and OUTM+/- test points to connect the left, right, and mono speakers directly to the EV kit.

The MAX9706 EV kit features PC board pads for filters that can be added to ease evaluation. Audio analyzers typically cannot accept pulse-width-modulated (PWM) signals at their inputs. The PWM output signal can be lowpass-filtered by installing components: L4–L9, C21–C35, and R1–R6 to use the filtering output pads (FOUTL+/-, FOUTR+/-, and FOUTM+/-). See Table 1 for the suggested filtering component values to evaluate a 4Ω load with a 30kHz cutoff frequency.

The MAX9706/MAX9707 are designed to pass FCC Class B RF emissions without additional filtering. In applications where a long cable is required, or the circuit is near EMI-sensitive devices, output capacitors C15–C20, and common-mode chokes T1–T3, can be added to reduce radiated emissions. Table 2 lists the recommended EMI filter components. Refer to the *Applications Information, Filterless Class D Operation* section in the MAX9706/MAX9707 IC data sheet for additional information.

Table 2. Recommended EMI Filter Components

COMPONENT	DESCRIPTION
C15–C20	100pF ±10%, 50V C0G ceramic capacitors (0603) TDK C1608C0G1H101K
T1, T2, T3	Common-mode chokes, 50VDC, 1.5ADC, 600Ω at 100MHz TDK ACM4532-601-2P-X

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Jumper Selection

Shutdown Mode (SHDN)

Jumper JU1 controls the shutdown mode (SHDN) of the MAX9706/MAX9707 ICs. The shutdown mode can also be controlled by an external logic controller connected to the EV kit SHDN PC board pad. Remove the shunt from jumper JU1 before connecting an external controller to the SHDN PC board pad. See Table 3 for shunt positions.

Mono Gain Offset Selection (MGAIN)

The MAX9706/MAX9707's mono channel is the sum of the left and right channels. Therefore, the mono channel has a +6dB gain higher than that of the left or the right channels. The MAX9706/MAX9707 provides an option to offset this +6dB gain. Jumper JU2 selects the mono amplifier gain offset on the EV kit. See Table 4 for shunt positions.

Gain Selection (GAIN1, GAIN2)

Jumpers JU3 and JU4 provide an option to set the speaker and headphone amplifiers' gain on the EV kit.

Table 3. JU1 Jumper Selection (SHDN)

SHUNT POSITION	SHDN PIN	EV KIT FUNCTION
1-2 (Default)	High	Enabled
2-3	Low	Disabled
None. External logic controller connected to SHDN pad.	Connected to external controller.	SHDN driven by external logic controller. Shutdown is active low.

See Table 5 for shunt positions. Note that the stereo speaker outputs are highpass-filtered by the crossover circuitry. The mono speaker output is lowpass-filtered by the crossover circuitry while the stereo headphone output has full bandwidth.

Crossover Frequency Selection (FS0, FS1)

Jumpers JU5 and JU6 provide an option to set the crossover frequency between stereo highpass outputs and the mono lowpass output for the MAX9706 EV kit. See Table 6 for shunt positions.

Synchronous Switching Input (SYNCIN)

The MAX9706 EV kit provides a SYNCIN PC board pad that allows the MAX9706/MAX9707 switching frequency to synchronize to an external TTL clock. The external clock frequency can range from 1MHz to 1.5MHz and can have any duty cycle, but the minimum pulse width must be greater than 100ns. The SYNCIN input on the EV kit also selects between the FFM and SSM mode for the MAX9706. Jumper JU7 selects between the FFM and SSM mode options for the MAX9706/MAX9707 ICs. See Table 7 for shunt positions.

Table 4. JU2 Jumper Selection (MGAIN Offset)

SHUNT POSITION	MGAIN PIN	MONO AMPLIFIER GAIN OFFSET (dB)
1-2*	High	-7.5
Not Installed*	Unconnected	-6.0
2-3*	Low	-4.5

*JU8 installed. Headphone not plugged in.

Table 5. JU3 and JU4 Jumper Selection (GAIN)

SHUNT POSITION		SPEAKER GAIN (dB) JU8 INSTALLED JU2 NOT INSTALLED	HEADPHONE GAIN (dB) JU8 NOT INSTALLED
JU3 (GAIN2)	JU4 (GAIN1)		
2-3 (Low)	2-3 (Low)	+9.0	0
2-3 (Low)	1-2 (High)	+10.5	0
1-2 (High)	2-3 (Low)	+12.0	+3
1-2 (High)	1-2 (High)	+13.5	+3

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Speaker/Headphone Mode (HPS)

Jumper JU8 selects between the speaker mode and the headphone mode for the MAX9706 EV kit. See Table 8 for shunt positions.

Table 6. JU5 and JU6 Jumper Selection (Crossover Frequency)

SHUNT POSITION		CROSSOVER FREQUENCY (Hz)
JU5 (FS0)	JU6 (FS1)	
2-3 (Low)	2-3 (Low)	800
2-3 (Low)	1-2 (High)	1066.7
1-2 (High)	2-3 (Low)	1600
1-2 (High)	1-2 (High)	2133.3

Table 7. JU7 Jumper Selection (Switching Frequency)

SHUNT POSITION	SYNC_IN CONNECTED TO	OPERATING MODE
1-2 (Default)	VDD	SSM with fosc = 1150kHz ± 50kHz
Not Installed	Unconnected	FFM with fosc = 1340kHz
2-3	GND	FFM with fosc = 1100kHz
Not Installed. External clock source connected to SYNCIN pad.	External clock source from 1MHz to 1.5MHz.	FFM with fosc = external clock frequency.

Evaluating the MAX9707

To evaluate the MAX9707, replace the MAX9706 IC with the MAX9707 IC. Refer to the MAX9706/MAX9707 IC data sheet for the pinout and function.

Table 8. JU8 Jumper Selection (SPKR/HP)

SHUNT POSITION	EV KIT FUNCTION
Not Installed	Forced headphone mode
Installed (No headphone plugged into J1)	Speaker mode
Installed (Headphone plugged into J1)	Headphone mode

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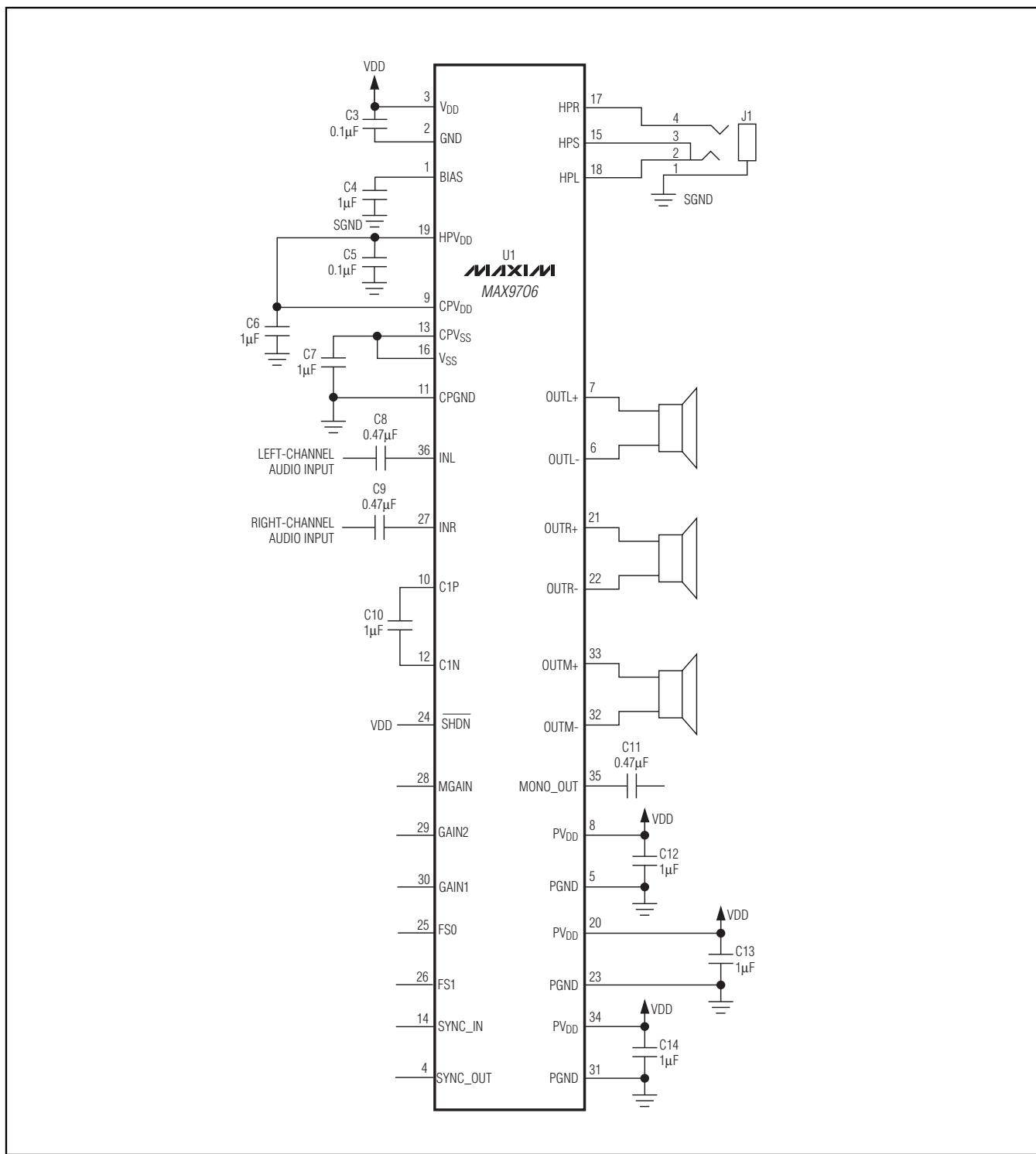


Figure 1. MAX9706 Customer Design Schematic

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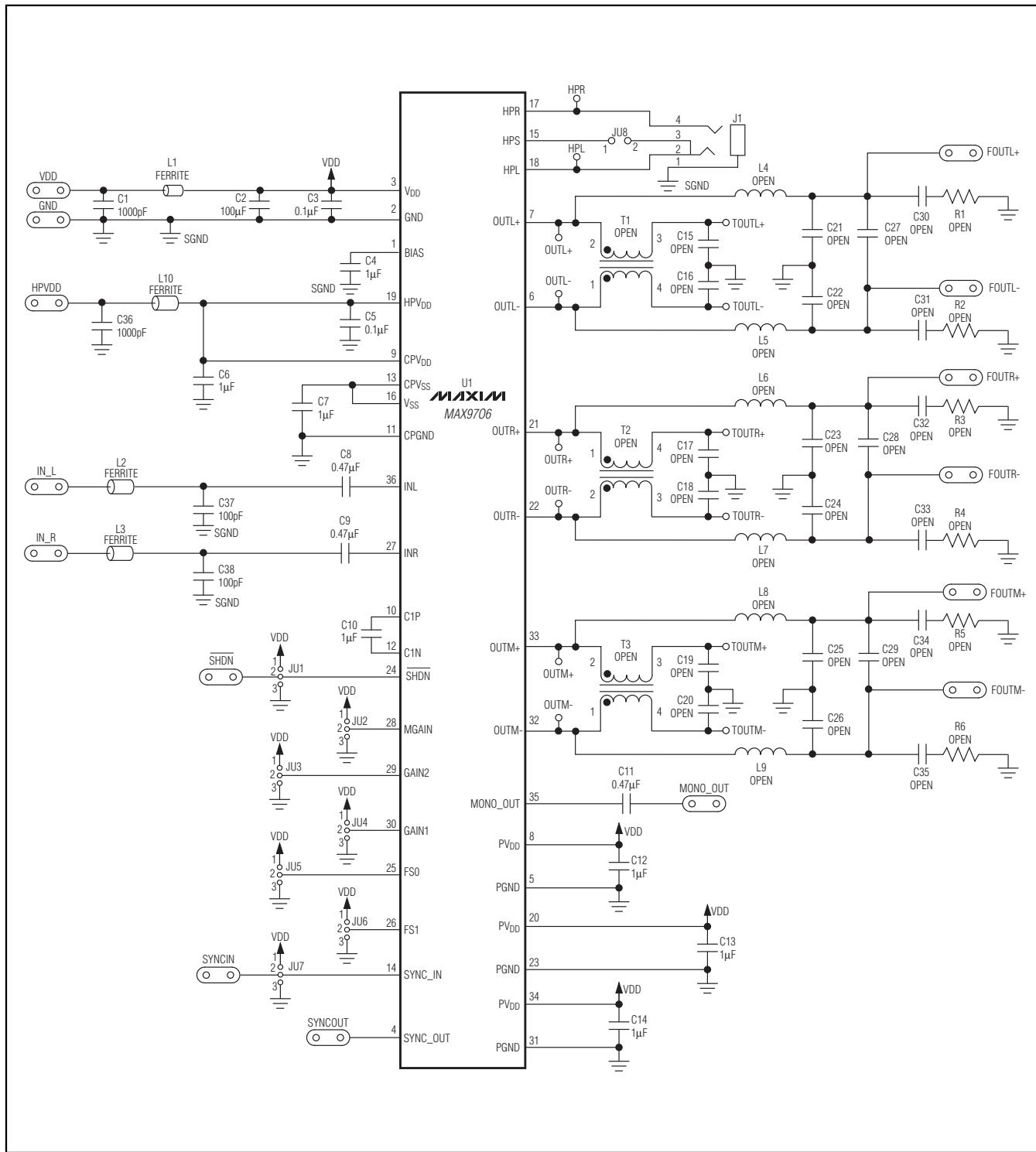


Figure 2. MAX9706 EV Kit Schematic

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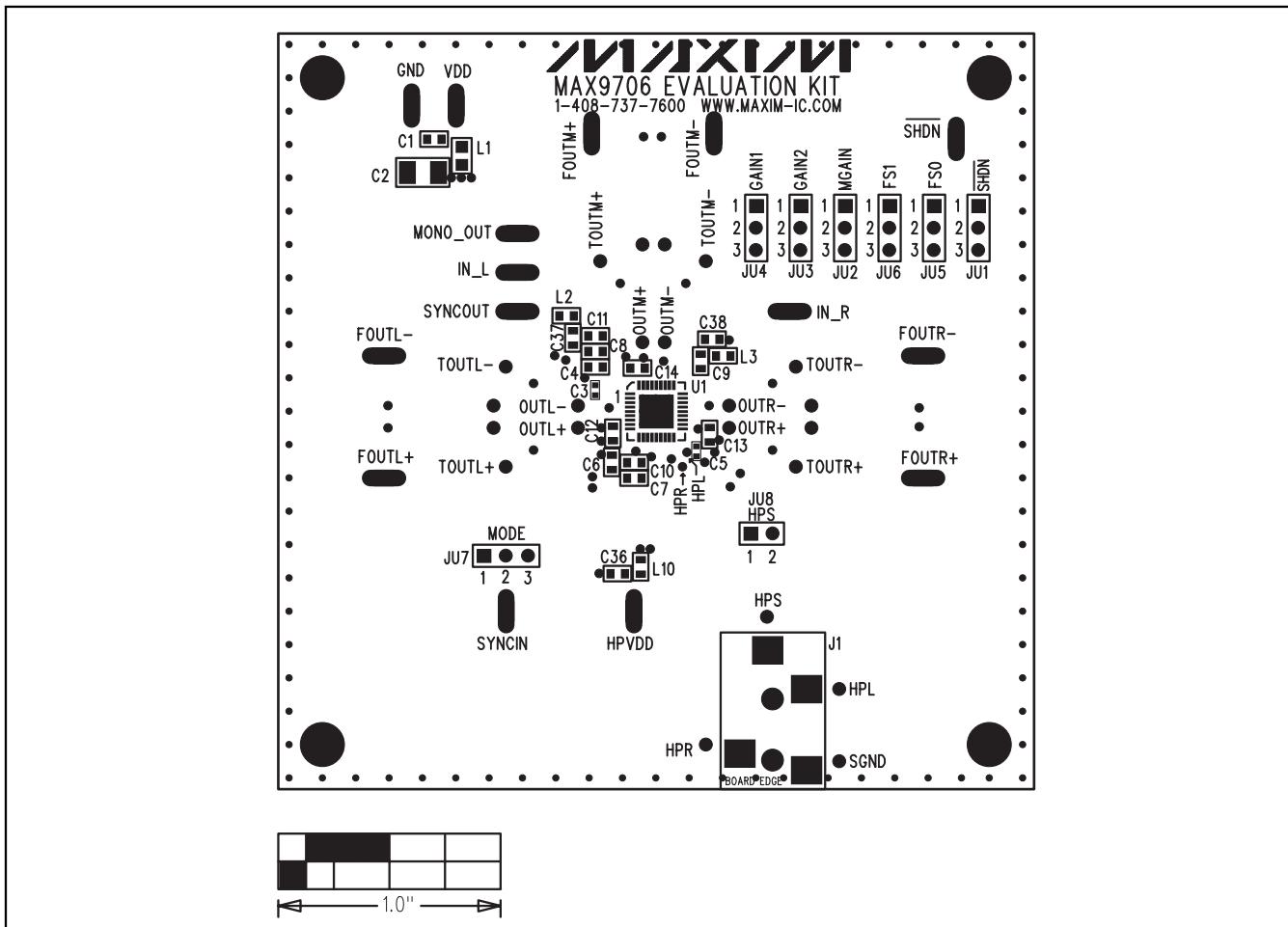


Figure 3. MAX9706 EV Kit Component Placement Guide—Component Side

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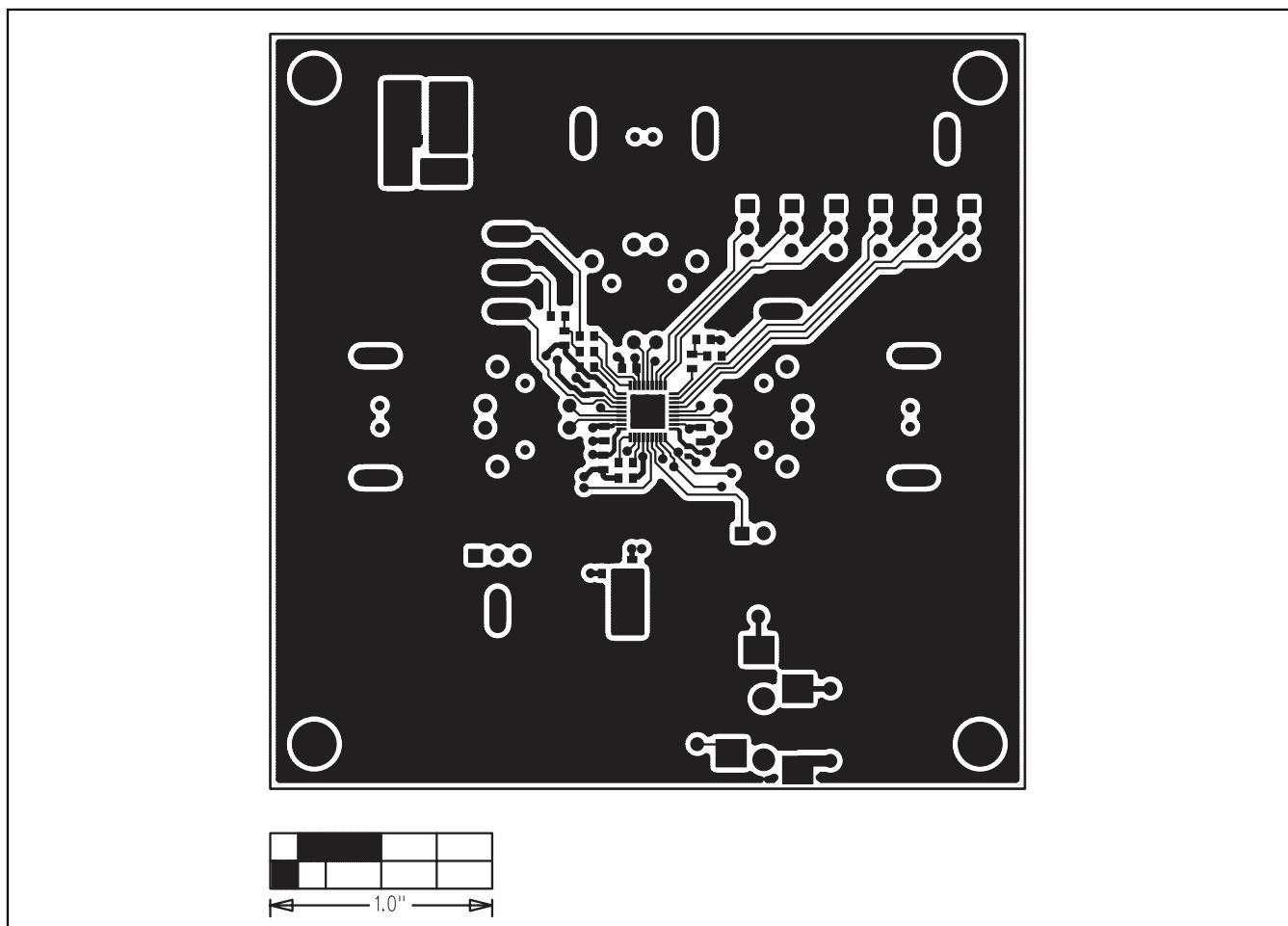


Figure 4. MAX9706 EV Kit PC Board Layout—Component Side

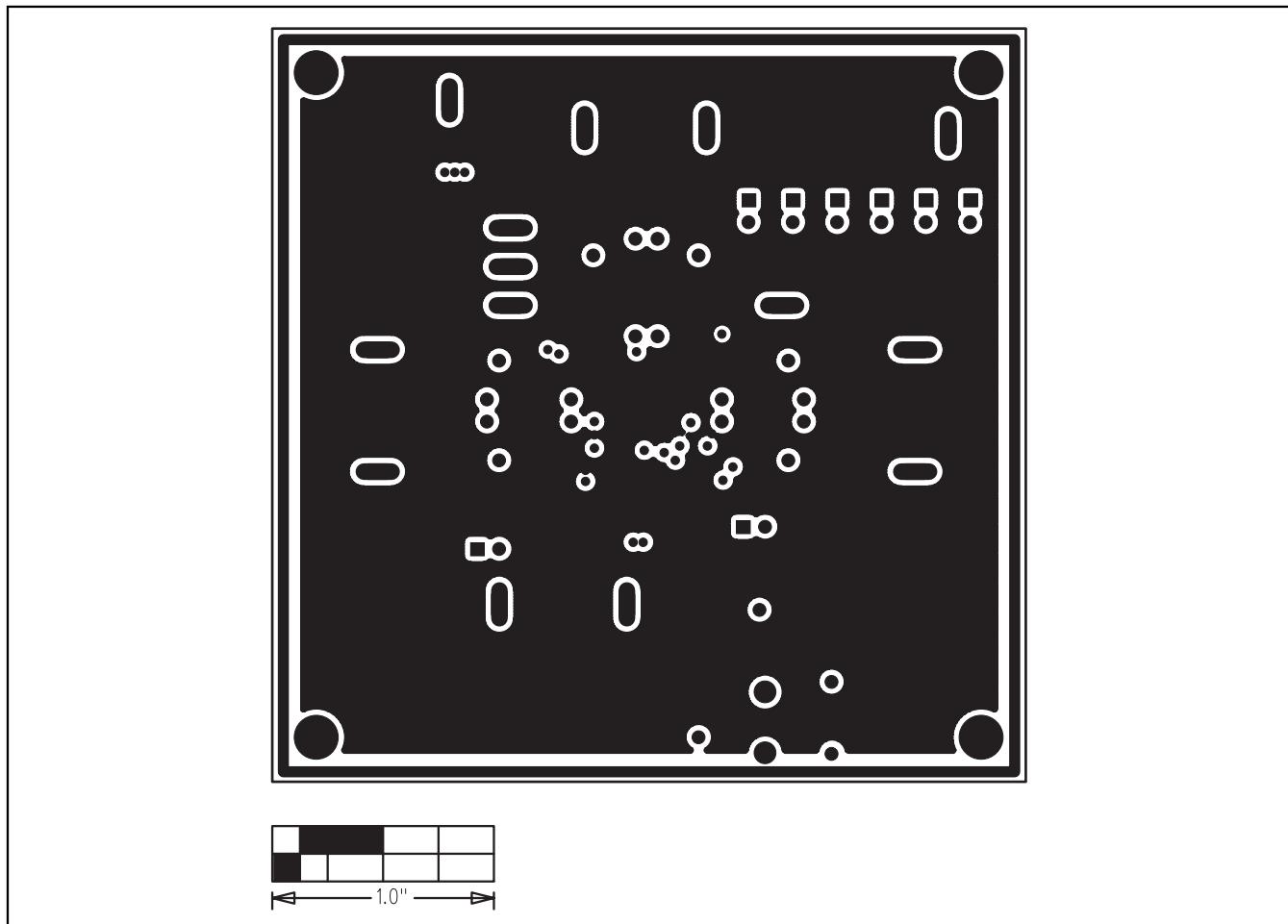


Figure 5. MAX9706 EV Kit PC Board Layout—GND Layer 2

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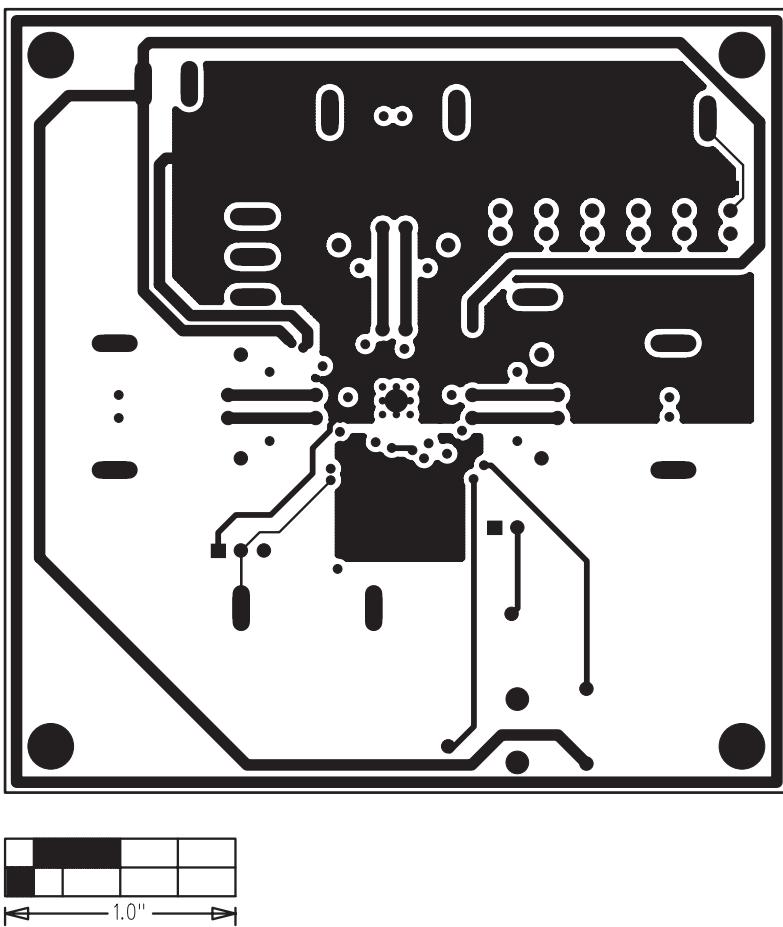


Figure 6. MAX9706 EV Kit PC Board Layout—VDD Layer 3

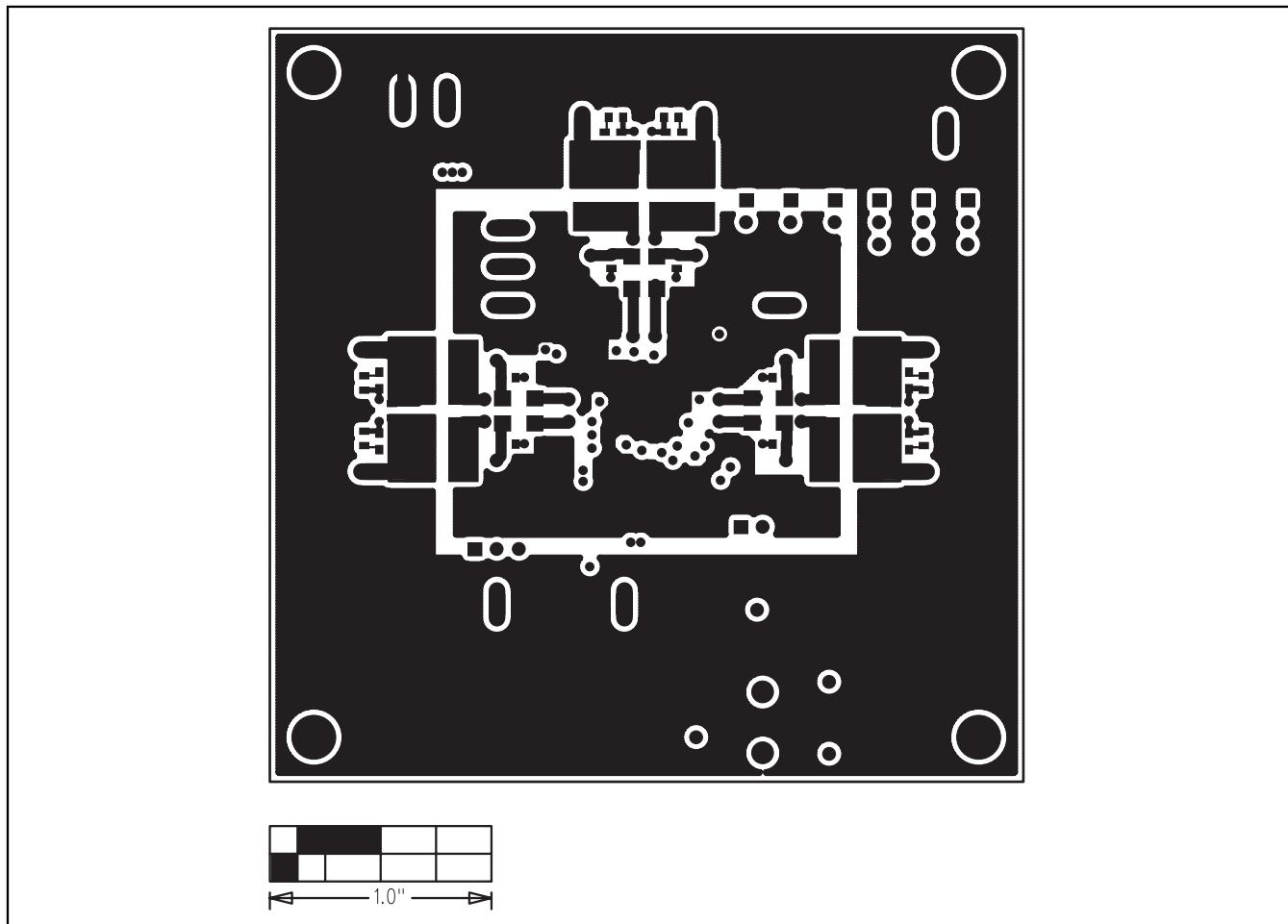


Figure 7. MAX9706 EV Kit PC Board Layout—Solder Side

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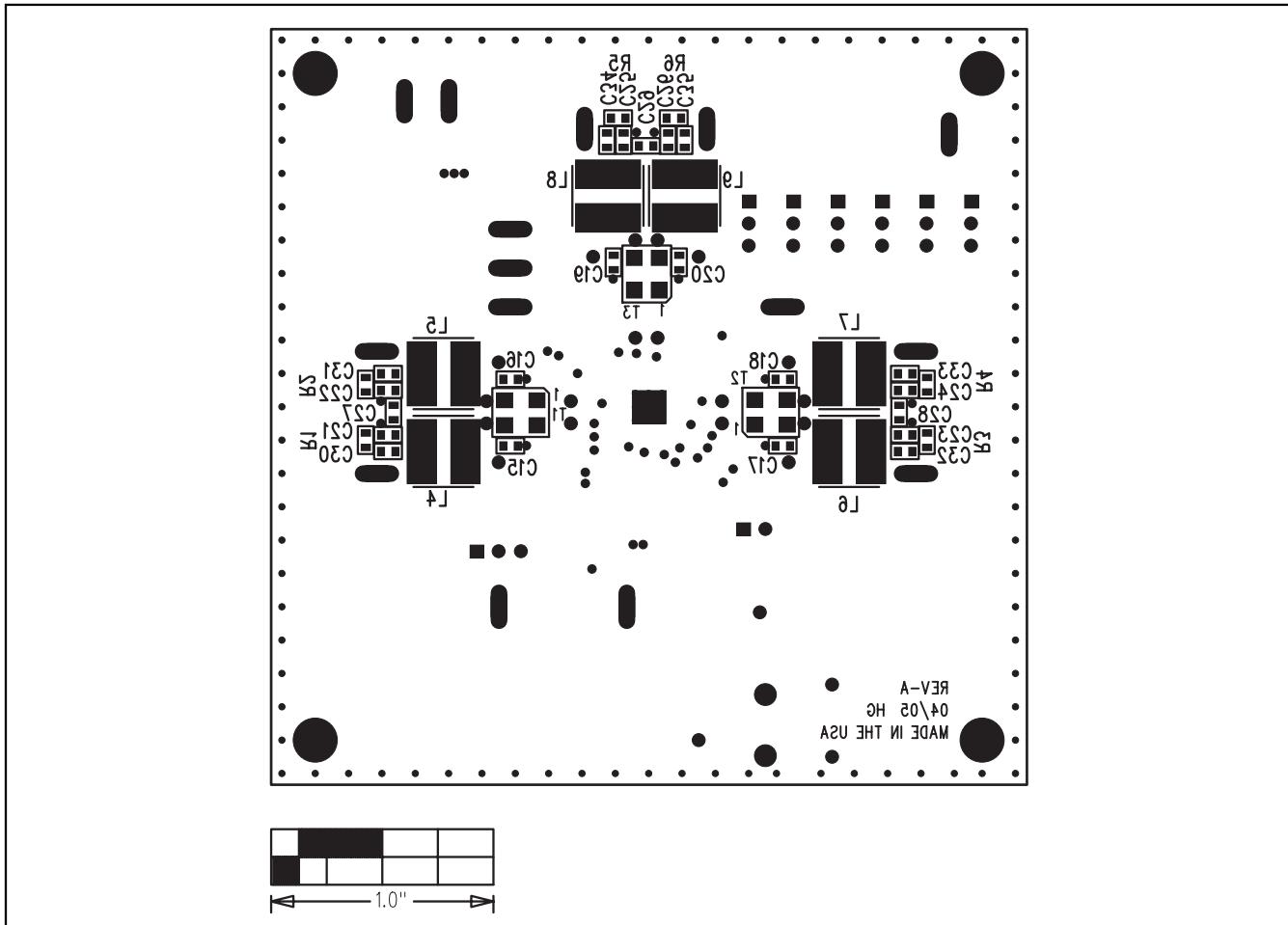


Figure 8. MAX9706 EV Kit Component Placement Guide—Solder Side

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Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600

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